

OPTIONS

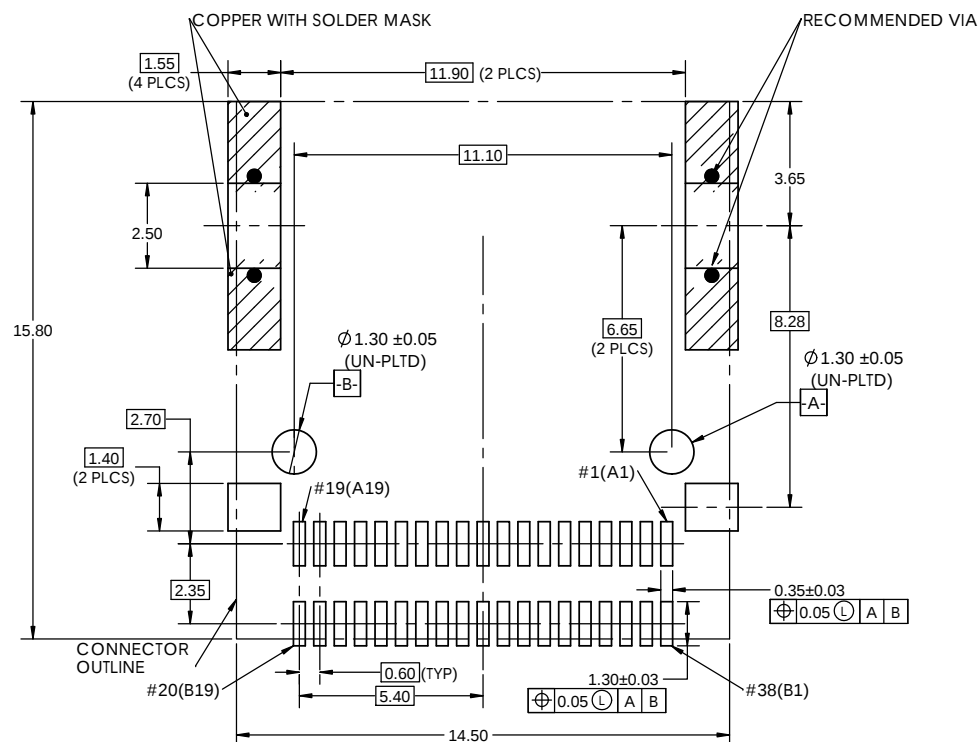
0T = STANDARD CONSTRUCTION WITH TAPE & REEL
PACKAGING

1T = NO RESONANCE DAMPING WITH TAPE & REEL
PACKAGING

CONTACT PLATING OPTION

2 = 30 MICROINCHES OF GOLD ON MATING END WITH 100 MICROINCHES MINIMUM OF MATTE TIN ON SOLDER TERMINATION. 50-75 MICROINCHES OF NICKEL UNDERPLATE ALL OVER

3 = 15 MICROINCHES OF GOLD ON MATING END WITH 100 MICROINCHES MINIMUM OF MATTE TIN ON SOLDER TERMINATION. 50-75 MICROINCHES OF NICKEL UNDERPLATE ALL OVER



NOTES:

1) MATERIAL:

HOUSING: SOLDER REFLOW PROCESS COMPATIBLE LCP, UL94V-0
CONTACTS: HIGH PERFORMANCE COPPER ALLOY
LATCH: PHOSPHOR BRONZE
RESONANCE DAMPENING FEATURE: SEMI-CONDUCTIVE POLYMER

2)RoHS COMPLIANT



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UNLESS SPECIFIED OTHERWISE		DRAWN		J.SI		DEC12/14		Amphenol High Speed Interconnects A Division of Amphenol Corp. www.amphenolcanada.com							
PRIMARY UNITS MILLIMETERS		CHECKED		M. E. APP'D				ULTRAPORT SLIMSAS™ 4X24 R/A RECEPTACLE WITH SMT LATCH							
SECONDARY				Q. A. APP'D											
REFERENCE IN PARENTHESES				DWG. APP'D											
GENERAL TOLERANCES		DWG. TOLERANCES		ECN TBD				P-U10-C038-X1XX							
1 DECIMAL PLACE ±0.35		ENG. REL. NO.				DWG. NO.								REV F	
2 DECIMAL PLACES ±0.25		REF.													
3 DECIMAL PLACES ±0.15		THIRD ANGLE PROJECTION				DO NOT SCALE DRAWING		CODE ID NO. 03554		DWG SIZE: C	SCALE: 5:1	SHEET 1 OF 1			
ANGULAR DEGREES ±2°															

Mouser Electronics

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